TOSHIBA BI-DIRECTIONAL TRIODE THYRISTOR SILICON PLANAR TYPE

SM10LZ47

AC POWER CONTROL APPLICATIONS

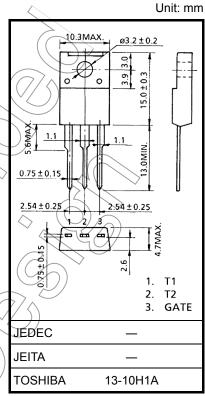
Repetitive Peak Off-State Voltage : V_{DRM} = 800V
 R.M.S. On-State Current : I_T (RMS) = 10A

• High Commutation (dv / dt)

• Isolation Voltage : VISOL = 1500V AC

ABSOLUTE MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	THAU
Repetitive Peak Off-State Voltage	V_{DRM}	800	$(\mathcal{N} \land)$
R.M.S On-State Current (Full Sine Waveform)	I _{T (RMS)}	10	A
Peak One Cycle Surge On-State Current (Non-Repetitive)	I _{TSM}	100 (50Hz) 110 (60Hz)	> A
I ² t Limit Value	I ² t	50	A ² s
Critical Rate of Rise of On-State Current (Note 1)	di / dt	50	Alus
Peak Gate Power Dissipation	P _{GM}	5	M
Average Gate Power Dissipation	P _G (AV))) 0.5	W
Peak Gate Voltage	VFGM	10 <	V
Peak Gate Current	(I _{GM})	2	A
Junction Temperature	i	-40~125) e
Storage Temperature Range	T _{stg}	-40~125	Ĵ~c
Isolation Voltage (AC, t = 1min.)	V _{ISOL}	(1500/	V



Weight: 1.7 g (typ.)

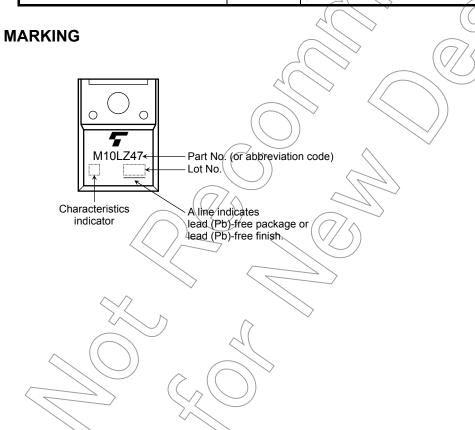
Note 1: di / dt test condition $V_{DRM} = 0.5 \times Rated$, $I_{DM} \le 15A$, $I_{gw} \ge 10 \mu s$, $I_{gr} \le 250 ns$, $I_{gp} = I_{GT} \times 2.0$

Note 2: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC SYMBOL TE		TEST C	CONDITION	MIN	TYP.	MAX	UNIT	
Repetitive Peak Off-State Current		I _{DRM}	V _{DRM} = Rated		_	_	20	μΑ
Gate Trigger Voltage	I		V _D = 12V, R _L = 20Ω	T2 (+) , Gate (+)	_	_	1.5	V
	II	V _{GT}		T2 (+) , Gate (-) <	1/	_	1.5	
	Ш			T2 (-) , Gate (-)	4	1	1.5	
Gate Trigger Current	I	I _{GT}	$V_D = 12V$, $R_L = 20\Omega$	T2 (+) , Gate (+)	J)	<u>}</u>	30	mA
	Ш			T2 (+), Gate) 		30	
	III			T2 (-), Gate (-)	\rightarrow	-	30	
Peak On-State Voltage		V_{TM}	I _{TM} = 15A		\	_	1.5	V
Gate Non-Trigger Voltage		$V_{\sf GD}$	V _D = Rated, Tc	0.2	-	_	V	
Holding Current		lΗ	V _D = 12V, I _{TM} = 1A		_		50	mA
Thermal Resistance R _{th}		R _{th (j-c)}	Junction to Case, AC		- /	4	3.4	°C/W
Critical Rate of Rise of Off-State Voltage dv / dt		V _{DRM} = 600V, T _j = 125°C Exponential Rise		(300	> _	V / µs	
Critical Rate of Rise of Off-State Vo at Commutation	ltage	(dv / dt) c V _{DRM} = 400V, T _j = 125°C (di / dt) c = -5.5A / ms		(30/		<i></i>	V / µs	



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